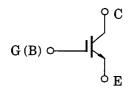
TOSHIBA IGBT Module Silicon N Channel IGBT

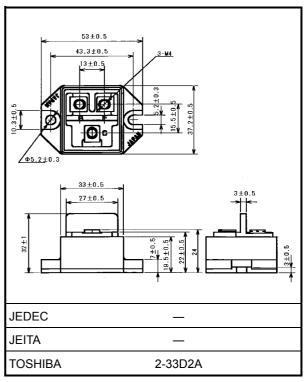
# MG50Q1BS11

High Power Switching Applications Motor Control Applications

- Enhancement-mode
- The electrodes are isolated from case.

### **Equivalent Circuit**





### Maximum Ratings (Ta = 25°C)

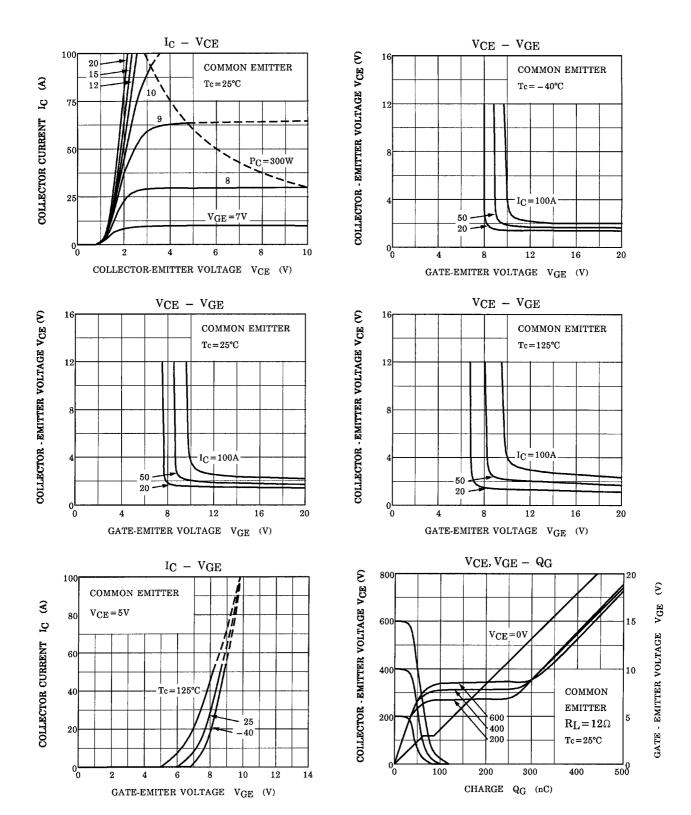
Characteristic		Symbol	Rating	Unit	
Collector-emitter voltage		V <sub>CES</sub>	1200	V	
Gate-emitter voltage		V <sub>GES</sub>	±20	V	
Collector current	DC	Ι <sub>C</sub>	50	А	
	1ms	I <sub>CP</sub>	100	~	
Collector power dissipation (Tc = 25°C)		P <sub>C</sub>	300	W	
Junction temperature		Тj	150	°C	
Storage temperature range		T <sub>stg</sub>	-40 to 125	°C	
Isolation voltage		V <sub>Isol</sub>	2500 (AC 1 minute)	V	
Screw torque (Terminal / mounting)		_	2/3	N∙m	

Unit: mm

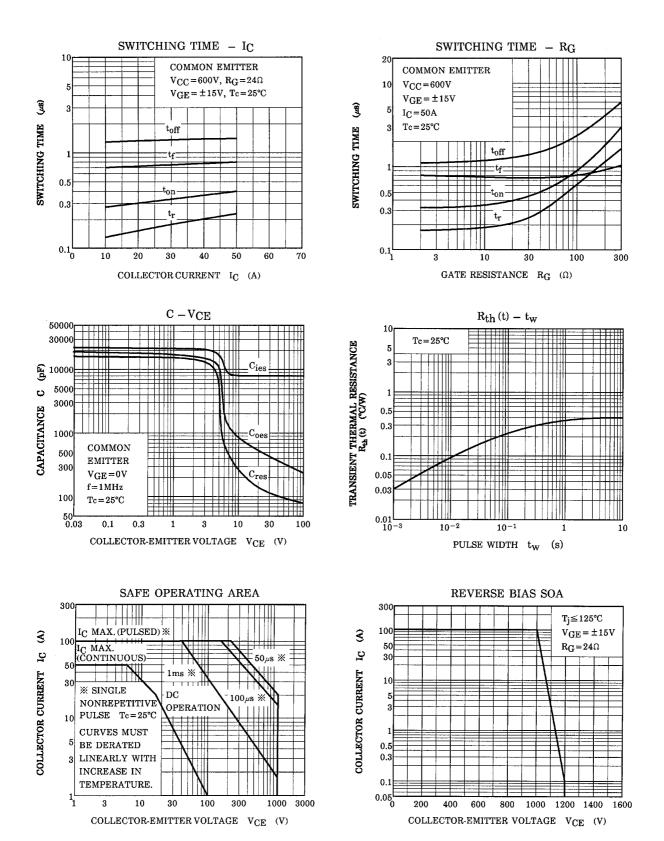
Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GES</sub>	$V_{GE}$ = ±20V, $V_{CE}$ = 0		_	±500	nA
Collector cut-off current		I <sub>CES</sub>	V <sub>CE</sub> = 1200V, V <sub>GE</sub> = 0	_	_	1.0	mA
Gate-emitter cut-off voltage		V <sub>GE (OFF)</sub>	I <sub>C</sub> = 50mA, V <sub>CE</sub> = 5V	3.0	-	6.0	V
Collector-emitter saturation voltage		V <sub>CE (sat)</sub>	I <sub>C</sub> = 50A, V <sub>GE</sub> = 15V		2.2	2.7	V
Input capacitance		C <sub>ies</sub>	V <sub>CE</sub> = 10V, V <sub>GE</sub> = 0, f = 1MHz	_	7800	_	pF
Switching time	Rise time	tr		_	0.3	0.6	- µs
	Turn-on time	t <sub>on</sub>		_	0.4	0.8	
	Fall time	t <sub>f</sub>		_	0.6	1.0	
	Turn-off time	t <sub>off</sub>		_	1.2	1.8	
Thermal resistance		R <sub>th (j-c)</sub>	600V	_	_	0.39	°C/W

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